

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
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YU ZHANG	12/16/2016
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PROPERTY NUMBERS Total: 1	
Property Type	Number
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DATE SIGNED:	02/10/2017
Total Attachments: 3	
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ASSIGNMENT

WHEREAS, we, Wen CHAI and Yu ZHANG (hereinafter referred to as ASSIGNORS), all having a mailing address of 2/F Baidu Campus, No. 10, Shangdi 10th Street, Haidian District Beijing 100085, China are the joint inventors of an invention entitled METHOD AND APPARATUS FOR LIVE-MIGRATING VIRTUAL MACHINES (“用于热迁移虚拟机的方法和装置”), as described and claimed in the specification for which an application for Chinese letters patent was filed on September 9, 2016 at the State Intellectual Property Office of China (SIPO), and assigned Application No. 201610812046.2.

WHEREAS, BEIJING BAIDU NETCOM SCIENCE AND TECHNOLOGY CO., LTD. (hereinafter referred to as ASSIGNEE), having a usual place of business at 2/F Baidu Campus, No. 10, Shangdi 10th Street, Haidian District Beijing 100085, China, is desirous of acquiring the entire right, title and interest in and to the invention and in and to any letters patent that may be granted therefor in and to all conventions and treaty rights of all kinds, in all countries throughout the world;

NOW, THEREFORE, in exchange for good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, ASSIGNORS hereby sell, assign and transfer unto said ASSIGNEE, the entire right, title and interest in and to said invention, said application and any and all letters patent which may be granted for said invention in and to all conventions and treaty rights of all kinds, in all countries throughout the world, for all such subject matter, including the right to claim for any such foreign applications any priority rights to which such applications are entitled under international conventions, treaties or otherwise and, in and to, all letters patent to be obtained for said subject matter by the above application or any continuation, division, continuation-in-part, extension, non-provisional or substitute thereof, including any corresponding right to claim priority from the patent application in any country or jurisdiction, re-examination or extension of said letters patent, including the right to sue and collect damages for past and present infringement of said letters patent; said invention, application and all letters patent on said invention to be held and enjoyed by ASSIGNEE and its successors and assigns for their use and benefit and of their successors and assigns as fully and entirely as the same would have been held and enjoyed by ASSIGNORS had this assignment, transfer and sale not been made. ASSIGNORS hereby authorize and request the patent office officials throughout the world to issue any and all letters patent on said invention to ASSIGNEE. ASSIGNORS agree to execute all instruments and documents required for the making and prosecution of applications for letters patent in and to all conventions and treaty rights of all

kinds, in all countries throughout the world on said invention, for litigation regarding said letters patent, or for the purpose of protecting title to said invention or letters patent therefor.

FURTHER, we agree that we will communicate to said ASSIGNEE or its representatives any facts known to us respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all papers relating to a continuation, division, continuation-in-part, extension, non-provisional or substitute thereof, including any corresponding right to claim priority from the patent application in any country or jurisdiction and any reissue, re-examination or extension of said letters patent, execute all necessary assignment papers to cause any and all of said letters patents to be issued to said ASSIGNEE, make all rightful oaths, and, generally do everything possible to aid said ASSIGNEE, its successors and assigns, to obtain and enforce proper protection for said invention throughout the world.

Date

December 16, 2016

Date

Wen CHAI

Yu ZHANG

Yu ZHANG

kinds, in all countries throughout the world on said invention, for litigation regarding said letters patent, or for the purpose of protecting title to said invention or letters patent therefor.

FURTHER, we agree that we will communicate to said ASSIGNEE or its representatives any facts known to us respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all papers relating to a continuation, division, continuation-in-part, extension, non-provisional or substitute thereof, including any corresponding right to claim priority from the patent application in any country or jurisdiction and any reissue, re-examination or extension of said letters patent, execute all necessary assignment papers to cause any and all of said letters patents to be issued to said ASSIGNEE, make all rightful oaths, and, generally do everything possible to aid said ASSIGNEE, its successors and assigns, to obtain and enforce proper protection for said invention throughout the world.

December 16, 2016
Date

Wen CHAI
Wen CHAI

Date

Yu ZHANG